2SC1568

Silicon NPN epitaxial planar type

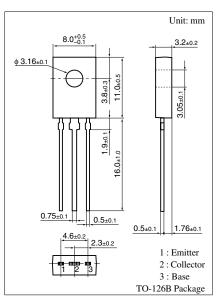
For low-voltage type medium output power amplification Complementary to 2SA0900 (2SA900)

Features

- Low collector to emitter saturation voltage $V_{CE(sat)}$
- Satisfactory operation performances and high efficiency with a low-voltage power supply
- TO-126B package which incorporates a unique construction enabling installation to the heat sink without using insulation parts

Symbol	Rating	Unit
V _{CBO}	18	V
V _{CEO}	18	V
V_{EBO}	5	V
I _{CP}	2	А
I _C	1	А
P _C	1.2	W
Tj	150	°C
T _{stg}	-55 to +150	°C
	$\begin{array}{c} V_{CBO} \\ V_{CEO} \\ V_{EBO} \\ I_{CP} \\ I_{C} \\ P_{C} \\ T_{j} \end{array}$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

Absolute Maximum Ratings $T_C = 25^{\circ}C$



Note) *: Without heat sink

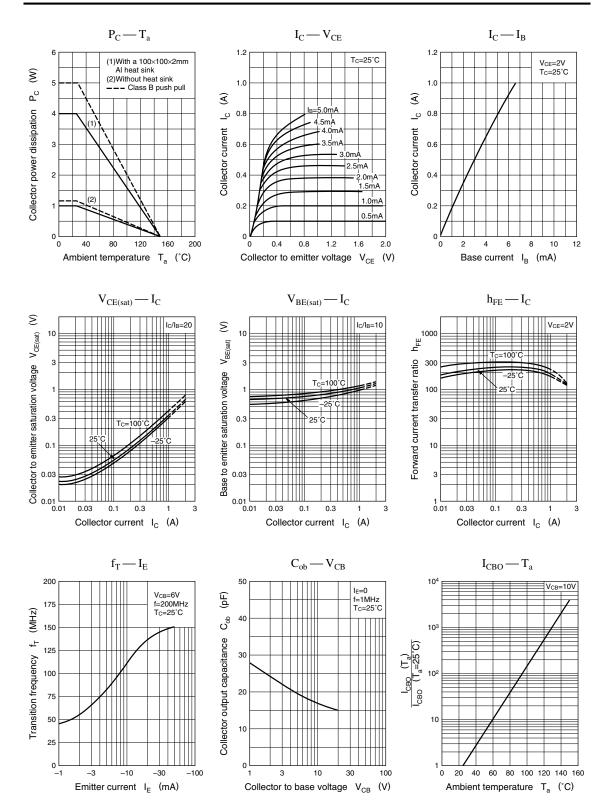
Electrical Characteristics $T_C = 25^{\circ}C$

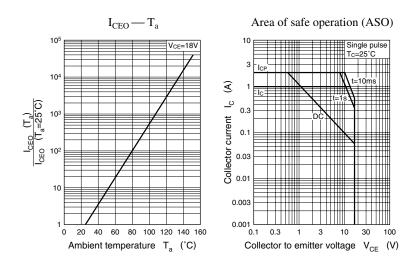
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector cutoff current	I _{CBO}	$V_{CB} = 10 \text{ V}, I_E = 0$			1	μΑ
	I _{CEO}	$V_{CE} = 18 \text{ V}, I_B = 0$			10	μΑ
Collector to base voltage	V _{CBO}	$I_{\rm C} = 10 \ \mu A, \ I_{\rm E} = 0$	18			V
Collector to emitter voltage	V _{CEO}	$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$	18			V
Emitter to base voltage	V_{EBO}	$I_{\rm E} = 10 \ \mu A, \ I_{\rm C} = 0$	5			V
Forward current transfer ratio	h _{FE1} *	$V_{CE} = 2 V, I_C = 500 mA$	90		280	
	h _{FE2}	$V_{CE} = 2 V, I_C = 1.5 A$	50	100		
Collector to emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 1 \text{ A}, I_{\rm B} = 50 \text{ mA}$			0.5	V
Base to emitter saturation voltage	V _{BE(sat)}	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 50 \text{ mA}$			1.2	V
Transition frequency	f _T	$V_{CB} = 6 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		150		MHz
Collector output capacitance	C _{ob}	$V_{CB} = 6 V, I_E = 0, f = 1 MHz$		12		pF

Note) *: Rank classification

Rank	Q	R	S
h _{FE1}	90 to 155	130 to 210	180 to 280

Note) The part number in the parenthesis shows conventional part number.





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